

Bipolar Transistor

-20 V, -5 A, Low V_{CE}(sat), PNP Single PCP

1 2 3

SOT-89 / PCP-1 CASE 419AU

2SB1302

特長

- FBET, MBIT プロセス採用
- 電流容量が大きい
- 小型でハイブリッドIC用として高密度化, 小型化が容易である
- コレクタ・エミッタ飽和電圧が低い
- スイッチングスピードが速い
- These Devices are Pb-Free and are RoHS Compliant

用途

DC-DC コンバータ,モータドライバ,リレードライバ, ランプドライバ

絶対最大定格 ABSOLUTE MAXIMUM RATINGS at Ta = 25℃

項目	記号	定格値	Unit
コレクタ・ベース電圧	V_{CBO}	-25	V
コレクタ・エミッタ電圧	V _{CEO}	-20	V
エミッタ・ベース電圧	V _{EBO}	-5	V
コレクタ電流	lc	-5	A
コレクタ電流(パルス)	I _{CP}	-8	A
コレクタ損失 (注1)	S Pc S	1,3	W
接合部温度	T	150	°C
保存周囲温度	T _{STG}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. (参考訳)

最大定格を超えるストレスは、デバイスにダメージを与える危険性があります。これらの定格値を超えた場合は、デバイスの機能性を損ない、ダメージが生じ、信頼性に影響を及ぼす危険性があります。

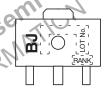
1. セラミック基板 (250 mm² x 0.8 mm) 装着時

電気的接続図



- 1: Base
- 2: Collector
- 3: Emitter

マーキング



ORDERING INFORMATION

Device	パッケージ名	最小梱包単位 [†]
2SB1302S-TD-E	PCP (Pb-Free)	1000 / Tape & Reel
2SB1302T-TD-E	PCP (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

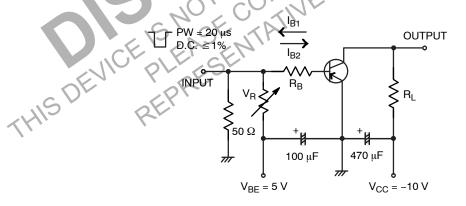
電気的特性 ELECTRICAL CHARACTERISTICS at TA = 25°C

			定格値			
項目	記号	条件	Min	Тур	Max	Unit
コレクタしゃ断電流	I _{CBO}	$V_{CB} = -20 \text{ V}, I_E = 0 \text{ A}$			-500	nA
エミッタしゃ断電流	I _{EBO}	$V_{EB} = -4V$, $I_{C} = 0$ A			-500	nA
直流電流増幅率	h _{FE} 1	$V_{CE} = -2 \text{ V}, I_{C} = -500 \text{ mA}$	140※		400※	
	h _{FE} 2	$V_{CE} = -2 \text{ V}, I_{C} = -4 \text{ A}$	60			
利得帯域幅積	f _T	$V_{CE} = -5 \text{ V}, I_{C} = -200 \text{ mA}$		320		MHz
出力容量	Cob	V _{CB} = -10 V, f = 1 MHz		60		pF
コレクタ・エミッタ飽和電圧	V _{CE} (sat)	$I_C = -3 \text{ A}, I_B = -60 \text{ mA}$		-250	-500	mV
ベース・エミッタ飽和電圧	V _{BE} (sat)	$I_C = -3 \text{ A}, I_B = -60 \text{ mA}$		-1.0	-1.3	V
コレクタ・ベース降伏電圧	V _{(BR)CBO}	$I_C = -10 \mu A, I_E = 0 A$	-25			V
コレクタ・エミッタ降伏電圧	V _{(BR)CEO}	$I_C = -1$ mA, $R_{BE} = \infty$	-20		1/2-	V
エミッタ・ベース降伏電圧	V _{(BR)EBO}	$I_E = -10 \mu A, I_C = 0 A$	-5		C/Q,	V
ターンオン時間	t _{on}	指定回路において		40	63.	ns
蓄積時間	t _{stg}			200		ns
下降時間	t _f			10		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. (参考訳)

ランク	S	T
h _{FE}	140 to 280	200 to 400

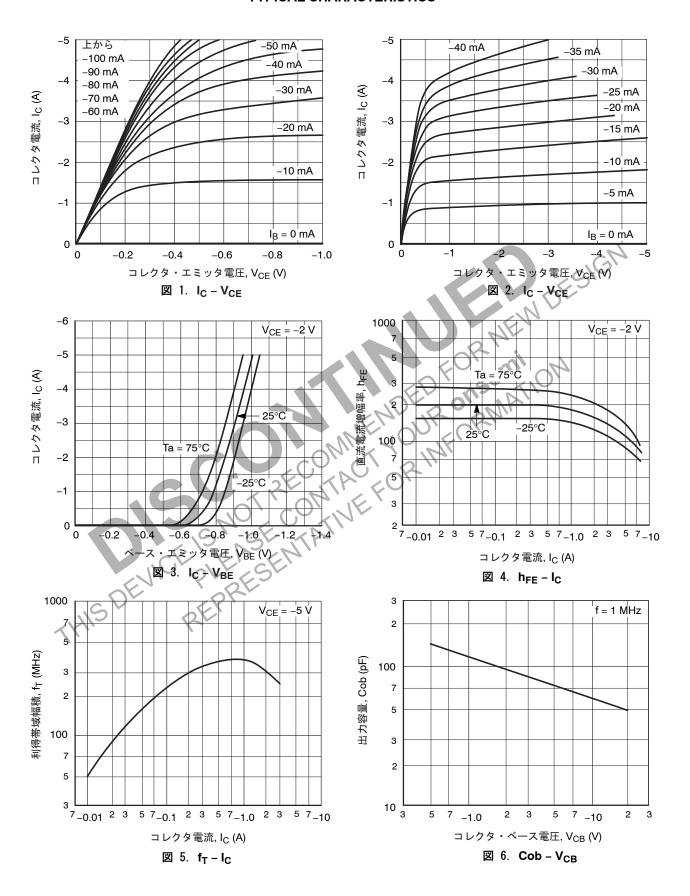
スイッチングタイム測定回路図



 $I_C = 10 \ I_{B1} = -10 \ I_{B2} = -2 \ A$

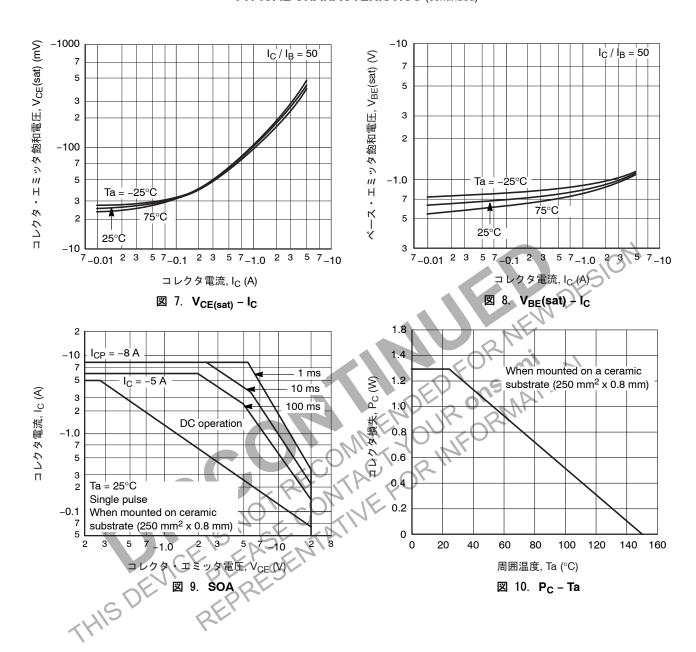
2SB1302

TYPICAL CHARACTERISTICS



2SB1302

TYPICAL CHARACTERISTICS (continued)







SOT-89 4.50x2.50x1.50 1.50P CASE 419AU **ISSUE A**

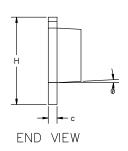
DATE 21 MAY 2025

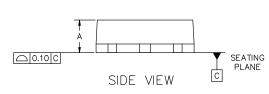
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS INCLUDES LEAD FINISH.

- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

MILLIMETERS			
DIM	MIN	NOM	MAX
Α	1.40	1.50	1.60
b	0.35	0.40	0.48
b1	0.40	0.50	0.55
С	0.37	0.40	0.43
D	4.40	4.50	4.60
D2	1.40	1.60	1.80
E	2.40	2.50	2.60
е	1.50 BSC		
Н	3.80	4.00	4.20
L	0.80	1.00	1.20
Θ	0.		3.

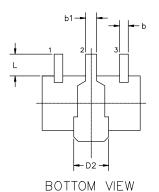


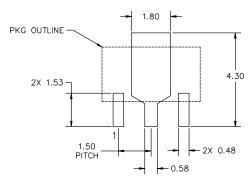


TOP VIEW

- A

В





RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb—Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON79746E Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-89 4.50x2.50x1.50 1.50P		PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales